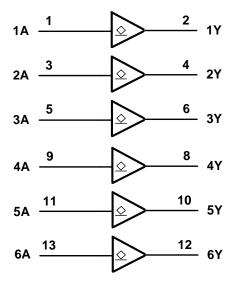


## **Pin Descriptions**

Pin Number	Pin Name	Description
1	1A	Data Input
2	1Y	Data Output
3	2A	Data Input
4	2Y	Data Output
5	3A	Data Input
6	3Y	Data Output
7	GND	Ground
8	4Y	Data Output
9	4A	Data Input
10	5Y	Data Output
11	5A	Data Input
12	6Y	Data Output
13	6A	Data Input
14	V <sub>CC</sub>	Supply Voltage

# **Logic Diagram**



## **Function Table**

Inputs	Outputs	
Α	Υ	
L	L	
Н	Z	



# **Absolute Maximum Ratings** (Note 4) ( $@T_A = +25^{\circ}C$ , unless otherwise specified.)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD CDM	Charged Device Model ESD Protection	1	KV
ESD MM	Machine Model ESD Protection	200	V
Vcc	Supply Voltage Range	-0.5 to +6.5	V
VI	Input Voltage Range	-0.5 to +6.5	V
Vo	Voltage applied to output in high impedance or I <sub>OFF</sub> state	-0.5 to +6.5	V
Vo	Voltage applied to output in high or low state	-0.3 to V <sub>CC</sub> +0.5	V
$I_{IK}$	Input Clamp Current V <sub>I</sub> < 0	-50	mA
I <sub>OK</sub>	Output Clamp Current V <sub>O</sub> < 0	-50	mA
lo	Continuous output current	50	mA
	Continuous current through Vdd or GND	±100	mA
TJ	Operating Junction Temperature	-40 to +150	°C
T <sub>STG</sub>	Storage Temperature	-65 to +150	°C
P <sub>TOT</sub>	Total Power Dissipation	500	mW

Note: 4. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.

# Recommended Operating Conditions (Note 5) (@TA = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	Supply Voltage		1.65	5.5	V
VI	Input Voltage		0	5.5	V
	Ontract Maltana	Active Mode	0	Vcc	V
Vo	Output Voltage	V <sub>CC</sub> = 0V; Power Down Mode	0	5.5	V
A./A.\		V <sub>CC</sub> = 1.65V to 2.7V		20	Δ.
Δt/ΔV	Input transition rise or fall rate	V <sub>CC</sub> = 2.7V to 5.5V		10	ns/V
T <sub>A</sub>	Operating free-air temperature		-40	+125	°C

Notes: 5. Unused inputs should be held at  $V_{CC}$  or Ground.



# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

			.,	T <sub>A</sub> = -40°C	C to +85°C	T <sub>A</sub> = -40°C	to +125°C	
Symbol	pol Parameter Test Conditions		V <sub>CC</sub>	Min	Max	Min	Max	Unit
			1.65V to 1.95V	0.65 X V <sub>CC</sub>		0.65 X V <sub>CC</sub>		
\ /	High-level Input		2.3V to 2.7V	1.7		1.6		
$V_{IH}$	Voltage		2.7V to 3.6V	2.0		2.0		V
			4.5V to 5.5V	0.7 X V <sub>CC</sub>		2.0		
			1.65V to 1.95V		0.35 X V <sub>CC</sub>		0.35 X V <sub>CC</sub>	
\ /	Low-level input		2.3V to 2.7V		0.7		0.7	
$V_{IL}$	voltage		2.7V to 3.6V		0.8		0.8	V
			4.5V to 5.5V		0.3 X V <sub>CC</sub>		0.3 X V <sub>CC</sub>	
		$I_{OL} = 100 \mu A$	A 1.65V to 5.5V 0.2		0.3			
		I <sub>OL</sub> = 4mA	1.65V		0.45		0.6	
		I <sub>OL</sub> = 8mA	2.3V		0.70		0.85	
$V_{OL}$	Low-level Output Voltage	404	2.7V		0.40		0.6	V
	Voltage	I <sub>OL</sub> = 12mA	3.0V		0.55		0.6	
		I <sub>OL</sub> = 24mA	3.0V		0.55		0.6	
		I <sub>OL</sub> = 32mA	4.5V		0.55		0.6	
lı	Input Current	$V_I = GND \text{ to } 5.5V$	3.6V		± 5		± 20	μΑ
I <sub>OZ</sub>	Z State Leakage Current	$V_O = GND \text{ or}$ 5.5V	3.6V		±10		±20	μΑ
l <sub>OFF</sub>	Power Down Leakage Current	$V_1$ or $V_0 = 0V$ to 3.6V	0		10		20	μА
Icc	Supply Current	$V_I = GND \text{ or } V_{CC}$ $I_O = 0$	3.6V		10		40	μA



## **Switching Characteristics**

Corrects at	Donometer	Test	V	T <sub>A</sub> = +25°C		-40°C to +85°C		-40°C to +125°C		I I m i t	
Symbol	Parameter	Conditions	V <sub>cc</sub>	Min	Тур	Max	Min	Max	Min	Max	Unit
		ropagation Figure 1 elay A <sub>N</sub> to Y <sub>N</sub>	1.65V to1.95V	0.3	2.9	5.7	0.3	5.8	0.3	7.6	
	Propagation		2.3V to 2.7V	0.3	2.6	4.1	0.3	4.7	0.3	5.5	
t <sub>PLZ</sub> /t <sub>PZL</sub>	Delay A <sub>N</sub> to Y <sub>N</sub>		2.7V	0.3	2.5	4.0	0.3	4.5	0.3	5.0	ns
			3V to 3.6V	0.3	2.3	3.5	0.3	3.7	0.3	5.0	
			4.5V to 5.5V	0.3	1.7	3.2	0.3	3.4	0.3	4.5	

# Operating Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

	Parameter	Test Conditions	V <sub>CC</sub> = 1.8V Typ	V <sub>CC</sub> = 2.5V Typ	V <sub>CC</sub> = 3.3V Typ	V <sub>CC</sub> = 5V Typ	Unit
$C_{\sf pd}$	Power dissipation capacitance per gate	f = 10 MHz	7.0	7.5	8.0	8.6	pF
Cı	Input Capacitance	$V_I = V_{CC} - or$ GND	4	4	4	4	pF

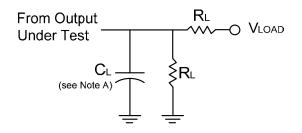
# **Package Characteristics**

Symbol	Parameter	Test Conditions	V <sub>cc</sub>	Min	Тур	Max	Unit
0	Thermal Resistance	SO-14	(1) ( 2)		TBD		°C/W
$\theta_{JA}$	Junction-to-Ambient	TSSOP-14	(Note 6)		159		
0	Thermal Resistance	SO-14	(1)		TBD		°C/W
$\theta_{JC}$	Junction-to-Case	TSSOP-14	(Note 6)		25		

Note: 6. Test condition for SO-14 and TSSOP-14: Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

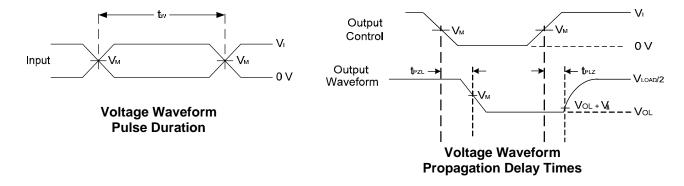


#### **Parameter Measuement Information**



TEST	Condition
t <sub>PLZ</sub> (see Note E)	$V_{LOAD}$
t <sub>PZL</sub> (see Note D)	$V_{LOAD}$

V	Inp	uts	, ,			ь	V.	
V <sub>CC</sub>	VI	t <sub>r</sub> /t <sub>f</sub>	V <sub>M</sub>	V <sub>LOAD</sub>	CL	$R_{L}$	<b>V</b> Δ	
1.8V±0.15V	V <sub>CC</sub>	≤2ns	V <sub>CC</sub> /2	2 X V <sub>CC</sub>	30pF	1ΚΩ	0.15V	
2.5V±0.2V	V <sub>CC</sub>	≤2ns	V <sub>CC</sub> /2	2 X V <sub>CC</sub>	30pF	500Ω	0.15V	
2.7V	2.7V	≤2ns	1.5V	6V	50pF	500Ω	0.3V	
3.3V±0.3V	3V	≤2.5ns	1.5V	6V	50pF	500Ω	0.3V	
5V±0.5V	V <sub>CC</sub>	≤2.5ns	V <sub>CC</sub> /2	2 X V <sub>CC</sub>	50pF	500Ω	0.3V	



Notes: A. Includes test lead and test apparatus capacitance.

B. All pulses are supplied at pulse repetition rate ≤ 10 MHz

C. The inputs are measured one at a time with one transition per measurement.

D.  $t_{PZL}$  is measured at  $V_{M}$ .

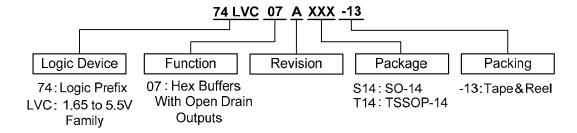
E.  $t_{PLZ}\,$  is measured at  $V_{OL}$  +  $V_{\Delta}$ 

Figure 1. Load Circuit and Voltage Waveforms

Downloaded from **Arrow.com**.



## **Ordering Information**

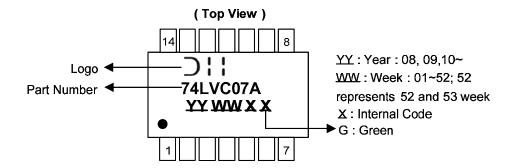


Dart Number	Package	Packaging	13" Тар	oe and Reel
Part Number	Code	(Note 7)	Quantity	Part Number Suffix
74LVC07AS14-13	S14	SO-14	2500/Tape & Reel	-13
74LVC07AT14-13	T14	TSSOP-14	2500/Tape & Reel	-13

Notes: 7. The taping orientation and tape details can be found at http://www.diodes.com/datasheets/ap02007.pdf

## **Marking Information**

#### (1) SO-14, TSSOP-14

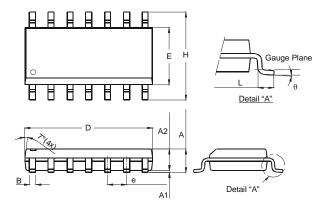


Part Number	Package
74LVC07AS14	SO-14
74LVC07AT14	TSSOP-14



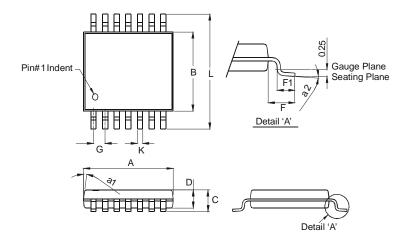
## Package Outline Dimensions (All dimensions in mm.)

#### Package Type: SO-14



SO-14			
Dim	Min	Max	
Α	1.47	1.73	
<b>A</b> 1	0.10	0.25	
A2	1.45 Typ		
В	0.33	0.51	
D	8.53	8.74	
Е	3.80	3.99	
е	1.27 Typ		
Н	5.80	6.20	
L	0.38	1.27	
θ	0°	8°	
All Dimensions in mm			

#### Package Type: TSSOP-14



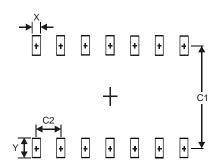
TSSOP-14			
Dim	Min	Max	
a1	7° (4X)		
a2	0°	8°	
Α	4.9	5.10	
В	4.30	4.50	
С	_	1.2	
D	0.8	1.05	
F	1.00 Typ		
F1	0.45	0.75	
G	0.65 Typ		
K	0.19	0.30	
L	6.40 Typ		
All Dimensions in mm			

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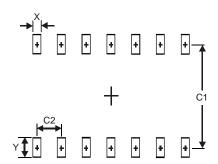
## **Suggested Pad Layout**

Package Type: SO-14



<b>Dimensions</b>	Value (in mm)	
Х	0.60	
Y	1.50	
C1	5.4	
C2	1.27	

Package Type: TSSOP-14



Dimensions	Value (in mm)
Х	0.45
Y	1.45
C1	5.9
C2	0.65



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